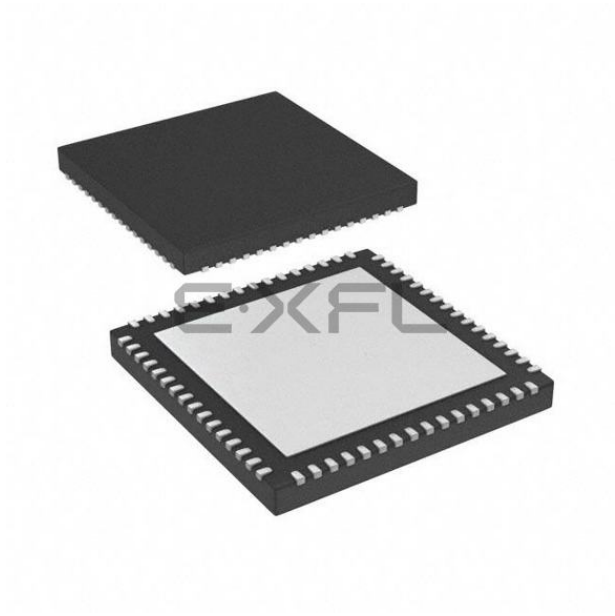

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Peripherals	Brown-out Detect/Reset, DMA, HLVD, POR, PWM, WDT
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Program Memory Type	FLASH
EEPROM Size	-
RAM Size	32K x 8
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Data Converters	A/D 16x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
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TABLE 4-11: SFR MAP: 0700h BLOCK

File Name	Address	All Resets	File Name	Address	All Resets
A/D			**PERIPHERAL PIN SELECT**		
ADC1BUF0	0712	xxxx	RPINR0	0790	3F3F
ADC1BUF1	0714	xxxx	RPINR1	0792	3F3F
ADC1BUF2	0716	xxxx	RPINR2	0794	3F3F
ADC1BUF3	0718	xxxx	RPINR3	0796	3F3F
ADC1BUF4	071A	xxxx	RPINR4	0798	3F3F
ADC1BUF5	071C	xxxx	RPINR5	079A	3F3F
ADC1BUF6	071E	xxxx	RPINR6	079C	3F3F
ADC1BUF7	0720	xxxx	RPINR7	079E	3F3F
ADC1BUF8	0722	xxxx	RPINR8	07A0	003F
ADC1BUF9	0724	xxxx	RPINR11	07A6	3F3F
ADC1BUF10	0726	xxxx	RPINR12	07A8	3F3F
ADC1BUF11	0728	xxxx	RPINR14	07AC	3F3F
ADC1BUF12	072A	xxxx	RPINR15	07AE	003F
ADC1BUF13	072C	xxxx	RPINR17	07B2	3F00
ADC1BUF14	072E	xxxx	RPINR18	07B4	3F3F
ADC1BUF15	0730	xxxx	RPINR19	07B6	3F3F
ADC1BUF16	0732	xxxx	RPINR20	07B8	3F3F
ADC1BUF17	0734	xxxx	RPINR21	07BA	3F3F
ADC1BUF18	0736	xxxx	RPINR22	07BC	3F3F
ADC1BUF19	0738	xxxx	RPINR23	07BE	3F3F
ADC1BUF20	073A	xxxx	RPINR25	07C2	3F3F
ADC1BUF21	073C	xxxx	RPINR27	07C6	3F3F
ADC1BUF22	073E	xxxx	RPINR28	07C8	3F3F
ADC1BUF23	0740	xxxx	RPINR29	07CA	003F
ADC1BUF24	0742	xxxx	RPOR0	07D4	0000
ADC1BUF25	0744	xxxx	RPOR1	07D6	0000
AD1CON1	0746	0000	RPOR2	07D8	0000
AD1CON2	0748	0000	RPOR3	07DA	0000
AD1CON3	074A	0000	RPOR4	07DC	0000
AD1CHS	074C	0000	RPOR5	07DE	0000
AD1CSSH	074E	0000	RPOR6	07E0	0000
AD1CSSL	0750	0000	RPOR7	07E2	0000
AD1CON4	0752	0000	RPOR8	07E4	0000
AD1CON5	0754	0000	RPOR9	07E6	0000
AD1CHITH	0756	0000	RPOR10	07E8	0000
AD1CHITL	0758	0000	RPOR11	07EA	0000
AD1CTMENH	075A	0000	RPOR12	07EC	0000
AD1CTMENL	075C	0000	RPOR13	07EE	0000
AD1RESDMA	075E	0000	RPOR14	07F0	0000
NVM			RPOR15	07F2	0000
NVMCON	0760	0000			
NVMADR	0762	xxxx			
NVMADRU	0764	00xx			
NVMKEY	0766	0000			

Legend: — = unimplemented, read as '0'; x = undefined. Reset values are shown in hexadecimal.

5.1 Summary of DMA Operations

The DMA Controller is capable of moving data between addresses according to a number of different parameters. Each of these parameters can be independently configured for any transaction; in addition, any or all of the DMA channels can independently perform a different transaction at the same time. Transactions are classified by these parameters:

- Source and destination (SFRs and data RAM)
- Data size (byte or word)
- Trigger source
- Transfer mode (One-Shot, Repeated or Continuous)
- Addressing modes (fixed address or address blocks, with or without address increment/decrement)

In addition, the DMA Controller provides channel priority arbitration for all channels.

5.1.1 SOURCE AND DESTINATION

Using the DMA Controller, data may be moved between any two addresses in the Data Space. The SFR space (0000h to 07FFh), or the data RAM space (0800h to FFFFh), can serve as either the source or the destination. Data can be moved between these areas in either direction or between addresses in either area. The four different combinations are shown in Figure 5-2.

If it is necessary to protect areas of data RAM, the DMA Controller allows the user to set upper and lower address boundaries for operations in the Data Space above the SFR space. The boundaries are set by the DMAH and DMAL Limit registers. If a DMA channel attempts an operation outside of the address boundaries, the transaction is terminated and an interrupt is generated.

5.1.2 DATA SIZE

The DMA Controller can handle both 8-bit and 16-bit transactions. Size is user-selectable using the SIZE bit (DMACHn<1>). By default, each channel is configured for word-sized transactions. When byte-sized transactions are chosen, the LSb of the source and/or destination address determines if the data represents the upper or lower byte of the data RAM location.

5.1.3 TRIGGER SOURCE

The DMA Controller can use any one of the device's interrupt sources to initiate a transaction. The DMA Trigger sources are listed in reverse order of their natural interrupt priority and are shown in Table 5-1.

Since the source and destination addresses for any transaction can be programmed independently of the Trigger source, the DMA Controller can use any Trigger to perform an operation on any peripheral. This also allows DMA channels to be cascaded to perform more complex transfer operations.

5.1.4 TRANSFER MODE

The DMA Controller supports four types of data transfers, based on the volume of data to be moved for each Trigger.

- One-Shot: A single transaction occurs for each Trigger.
- Continuous: A series of back-to-back transactions occur for each Trigger; the number of transactions is determined by the DMACNTn transaction counter.
- Repeated One-Shot: A single transaction is performed repeatedly, once per Trigger, until the DMA channel is disabled.
- Repeated Continuous: A series of transactions are performed repeatedly, one cycle per Trigger, until the DMA channel is disabled.

All transfer modes allow the option to have the source and destination addresses, and counter value automatically reloaded after the completion of a transaction. Repeated mode transfers do this automatically.

5.1.5 ADDRESSING MODES

The DMA Controller also supports transfers between single addresses or address ranges. The four basic options are:

- Fixed-to-Fixed: Between two constant addresses
- Fixed-to-Block: From a constant source address to a range of destination addresses
- Block-to-Fixed: From a range of source addresses to a single, constant destination address
- Block-to-Block: From a range to source addresses to a range of destination addresses

The option to select auto-increment or auto-decrement of source and/or destination addresses is available for Block Addressing modes.

In addition to the four basic modes, the DMA Controller also supports Peripheral Indirect Addressing (PIA) mode, where the source or destination address is generated jointly by the DMA Controller and a PIA capable peripheral. When enabled, the DMA channel provides a base source and/or destination address, while the peripheral provides a fixed range offset address.

For PIC24FJ1024GA610/GB610 family devices, the 12-bit A/D Converter module is the only PIA capable peripheral. Details for its use in PIA mode are provided in **Section 25.0 "12-Bit A/D Converter with Threshold Detect"**.

REGISTER 11-8: IOCSTAT: INTERRUPT-ON-CHANGE STATUS REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	R/HS/HC-0	R/HS/HC-0	R/HS/HC-0	R/HS/HC-0	R/HS/HC-0	R/HS/HC-0	R/HS/HC-0
—	IOCPGF	IOCPFF	IOCPEF	IOCPDF	IOCPCF	IOCPBF	IOCPAF
bit 7							bit 0

Legend:	HS = Hardware Settable bit	Hardware Clearable bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-7 **Unimplemented:** Read as '0'

bit 6 **IOCPGF:** Interrupt-on-Change PORTG Flag bit
1 = A change was detected on an IOC-enabled pin on PORTG
0 = No change was detected or the user has cleared all detected changes

bit 5 **IOCPFF:** Interrupt-on-Change PORTF Flag bit
1 = A change was detected on an IOC-enabled pin on PORTF
0 = No change was detected or the user has cleared all detected changes

bit 4 **IOCPEF:** Interrupt-on-Change PORTE Flag bit
1 = A change was detected on an IOC-enabled pin on PORTE
0 = No change was detected or the user has cleared all detected changes

bit 3 **IOCPDF:** Interrupt-on-Change PORTD Flag bit
1 = A change was detected on an IOC-enabled pin on PORTD
0 = No change was detected or the user has cleared all detected changes

bit 2 **IOCPCF:** Interrupt-on-Change PORTC Flag bit
1 = A change was detected on an IOC-enabled pin on PORTC
0 = No change was detected or the user has cleared all detected changes

bit 1 **IOCPBF:** Interrupt-on-Change PORTB Flag bit
1 = A change was detected on an IOC-enabled pin on PORTB
0 = No change was detected or the user has cleared all detected changes

bit 0 **IOCPAF:** Interrupt-on-Change PORTA Flag bit
1 = A change was detected on an IOC-enabled pin on PORTA
0 = No change was detected, or the user has cleared all detected change

16.5 Auxiliary Output

The MCCPx and SCCPx modules have an auxiliary (secondary) output that provides other peripherals access to internal module signals. The auxiliary output is intended to connect to other MCCPx or SCCPx modules, or other digital peripherals, to provide these types of functions:

- Time Base Synchronization
- Peripheral Trigger and Clock Inputs
- Signal Gating

The type of output signal is selected using the AUXOUT<1:0> control bits (CCPxCON2H<4:3>). The type of output signal is also dependent on the module operating mode.

On the PIC24FJ1024GA610/GB610 family of devices, only the CTMU discharge Trigger has access to the auxiliary output signal.

TABLE 16-4: AUXILIARY OUTPUT

AUXOUT<1:0>	CCSEL	MOD<3:0>	Comments	Signal Description
00	x	xxxx	Auxiliary Output Disabled	No Output
01	0	0000	Time Base Modes	Time Base Period Reset or Rollover
10				Special Event Trigger Output
11				No Output
01	0	0001 through 1111	Output Compare Modes	Time Base Period Reset or Rollover
10				Output Compare Event Signal
11				Output Compare Signal
01	1	xxxx	Input Capture Modes	Time Base Period Reset or Rollover
10				Reflects the Value of the ICDIS bit
11				Input Capture Event Signal

TABLE 16-5: SYNCHRONIZATION SOURCES

SYNC<4:0>	Synchronization Source
11111	None; Timer with Rollover on CCPxPR Match or FFFFh
11110	Reserved
11101	Reserved
11100	CTMU Trigger
11011	A/D Start Conversion
11010	CMP3 Trigger
11001	CMP2 Trigger
11000	CMP1 Trigger
10111	Reserved
10110	Reserved
10101	Reserved
10100	Reserved
10011	CLC4 Out
10010	CLC3 Out
10001	CLC2 Out
10000	CLC1 Out
01111	Reserved
01110	Reserved
01101	Reserved
01100	Reserved
01011	INT2 Pad
01010	INT1 Pad
01001	INT0 Pad
01000	SCCP7 Sync Out
00111	SCCP6 Sync Out
00110	SCCP5 Sync Out
00101	SCCP4 Sync Out
00100	MCCP3 Sync Out
00011	MCCP2 Sync Out
00010	MCCP1 Sync Out
00001	MCCPx/SCCPx Sync Out(1)
00000	MCCPx/SCCPx Timer Sync Out(1)

Note 1: CCP1 when connected to CCP1, CCP2 when connected to CCP2, etc.

REGISTER 18-1: I2CxCONL: I2Cx CONTROL REGISTER LOW

R/W-0	U-0	R/W-0, HC	R/W-1	R/W-0	R/W-0	R/W-0	R/W-0
I2CEN	—	I2CSIDL	SCLREL(1)	STRICT	A10M	DISSLW	SMEN
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0, HC	R/W-0, HC	R/W-0, HC	R/W-0, HC	R/W-0, HC
GCEN	STREN	ACKDT	ACKEN	RCEN	PEN	RSEN	SEN
bit 7							bit 0

Legend:	HC = Hardware Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **I2CEN:** I2Cx Enable bit (writable from software only)
1 = Enables the I2Cx module and configures the SDAx and SCLx pins as serial port pins
0 = Disables the I2Cx module; all I^2C pins are controlled by port functions

bit 14 **Unimplemented:** Read as '0'

bit 13 **I2CSIDL:** I2Cx Stop in Idle Mode bit
1 = Discontinues module operation when device enters Idle mode
0 = Continues module operation in Idle mode

bit 12 **SCLREL:** SCLx Release Control bit (I^2C Slave mode only)(1)
Module resets and (I2CEN = 0) sets SCLREL = 1.
If STREN = 0:(2)
1 = Releases clock
0 = Forces clock low (clock stretch)
If STREN = 1:
1 = Releases clock
0 = Holds clock low (clock stretch); user may program this bit to '0', clock stretch at next SCLx low

bit 11 **STRICT:** I2Cx Strict Reserved Address Rule Enable bit
1 = Strict reserved addressing is enforced; for reserved addresses, refer to Table 18-2.
In Slave Mode: The device doesn't respond to reserved address space and addresses falling in that category are NACKed.
In Master Mode: The device is allowed to generate addresses with reserved address space.
0 = Reserved addressing would be Acknowledged.
In Slave Mode: The device will respond to an address falling in the reserved address space. When there is a match with any of the reserved addresses, the device will generate an ACK.
In Master Mode: Reserved.

bit 10 **A10M:** 10-Bit Slave Address Flag bit
1 = I2CxADD is a 10-bit slave address
0 = I2CxADD is a 7-bit slave address

bit 9 **DISSLW:** Slew Rate Control Disable bit
1 = Slew rate control is disabled for Standard Speed mode (100 kHz, also disabled for 1 MHz mode)
0 = Slew rate control is enabled for High-Speed mode (400 kHz)

bit 8 **SMEN:** SMBus Input Levels Enable bit
1 = Enables input logic so thresholds are compliant with the SMBus specification
0 = Disables SMBus-specific inputs

Note 1: Automatically cleared to '0' at the beginning of slave transmission; automatically cleared to '0' at the end of slave reception. The user software must provide a delay between writing to the transmit buffer and setting the SCLREL bit. This delay must be greater than the minimum set up time for slave transmissions, as specified in **Section 33.0 "Electrical Characteristics"**.

2: Automatically cleared to '0' at the beginning of slave transmission.

19.1 UARTx Baud Rate Generator (BRG)

The UARTx module includes a dedicated, 16-bit Baud Rate Generator. The UxBRG register controls the period of a free-running, 16-bit timer. Equation 19-1 shows the formula for computation of the baud rate when BRGH = 0.

EQUATION 19-1: UARTx BAUD RATE WITH BRGH = 0(1,2)

$$\text{Baud Rate} = \frac{F_{CY}}{16 \bullet (\text{UxBRG} + 1)}$$

$$\text{UxBRG} = \frac{F_{CY}}{16 \bullet \text{Baud Rate}} - 1$$

Note 1: FCY denotes the instruction cycle clock frequency (FOSC/2).

2: Based on FCY = FOSC/2; Doze mode and PLL are disabled.

Example 19-1 shows the calculation of the baud rate error for the following conditions:

- FCY = 4 MHz
- Desired Baud Rate = 9600

The maximum baud rate (BRGH = 0) possible is FCY/16 (for UxBRG = 0) and the minimum baud rate possible is FCY/(16 * 65536).

Equation 19-2 shows the formula for computation of the baud rate when BRGH = 1.

EQUATION 19-2: UARTx BAUD RATE WITH BRGH = 1(1,2)

$$\text{Baud Rate} = \frac{F_{CY}}{4 \bullet (\text{UxBRG} + 1)}$$

$$\text{UxBRG} = \frac{F_{CY}}{4 \bullet \text{Baud Rate}} - 1$$

Note 1: FCY denotes the instruction cycle clock frequency.

2: Based on FCY = FOSC/2; Doze mode and PLL are disabled.

The maximum baud rate (BRGH = 1) possible is FCY/4 (for UxBRG = 0) and the minimum baud rate possible is FCY/(4 * 65536).

Writing a new value to the UxBRG register causes the BRG timer to be reset (cleared). This ensures the BRG does not wait for a timer overflow before generating the new baud rate.

EXAMPLE 19-1: BAUD RATE ERROR CALCULATION (BRGH = 0)(1)

Desired Baud Rate = FCY/(16 (UxBRG + 1))

Solving for UxBRG Value:

UxBRG = ((FCY/Desired Baud Rate)/16) – 1
UxBRG = ((4000000/9600)/16) – 1
UxBRG = 25

Calculated Baud Rate = 4000000/(16 (25 + 1))
= 9615

Error = (Calculated Baud Rate – Desired Baud Rate) / Desired Baud Rate
= (9615 – 9600)/9600
= 0.16%

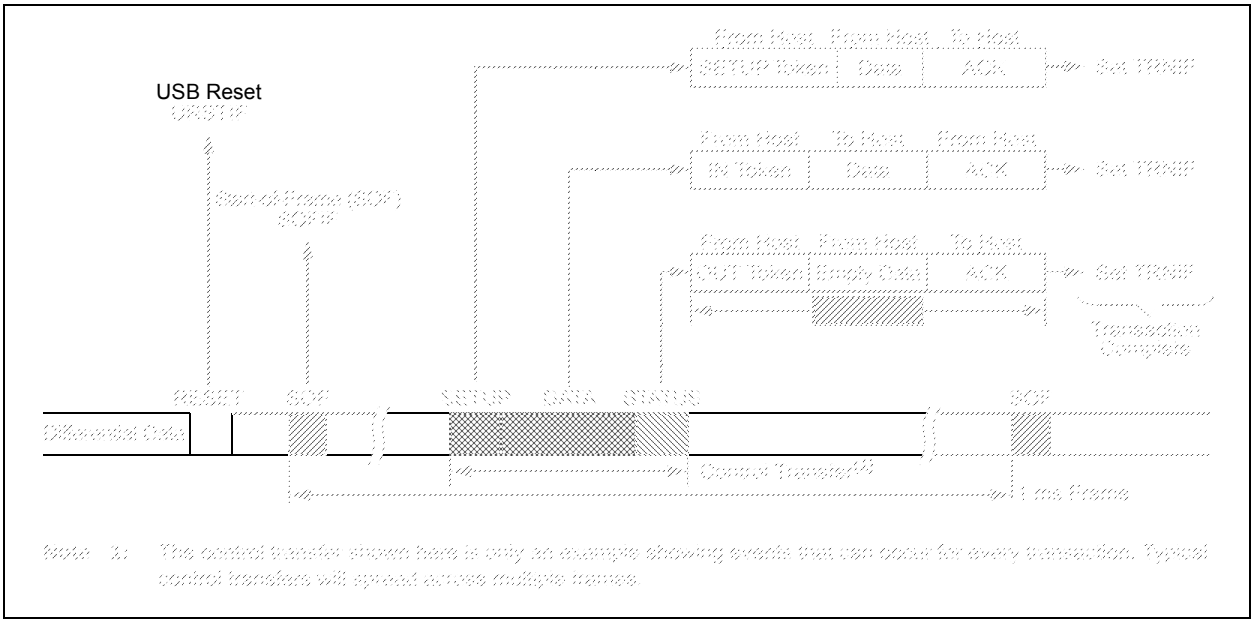
Note 1: Based on FCY = FOSC/2; Doze mode and PLL are disabled.

20.3.1 CLEARING USB OTG INTERRUPTS

Unlike device-level interrupts, the USB OTG interrupt status flags are not freely writable in software. All USB OTG flag bits are implemented as hardware set only bits. Additionally, these bits can only be cleared in software by writing a '1' to their locations (i.e., performing a MOV type instruction). Writing a '0' to a flag bit (i.e., a BCLR instruction) has no effect.

Note:	Throughout this data sheet, a bit that can only be cleared by writing a '1' to its location is referred to as "Write '1' to Clear". In register descriptions; this function is indicated by the descriptor, "K".

FIGURE 20-9: EXAMPLE OF A USB TRANSACTION AND INTERRUPT EVENTS



20.4 Device Mode Operation

The following section describes how to perform a common Device mode task. In Device mode, USB transfers are performed at the transfer level. The USB module automatically performs the status phase of the transfer.

20.4.1 ENABLING DEVICE MODE

1. Reset the Ping-Pong Buffer Pointers by setting, then clearing, the Ping-Pong Buffer Reset bit, PPBRST (U1CON<1>).
2. Disable all interrupts (U1IE and U1EIE = 00h).
3. Clear any existing interrupt flags by writing FFh to U1IR and U1EIR.
4. Verify that VBUS is present (non-OTG devices only).
5. Enable the USB module by setting the USBEN bit (U1CON<0>).
6. Set the OTGEN bit (U1OTGCON<2>) to enable OTG operation.
7. Enable the Endpoint 0 buffer to receive the first setup packet by setting the EPRXEN and EPHSHK bits for Endpoint 0 (U1EP0<3,0> = 1).
8. Power up the USB module by setting the USBPWR bit (U1PWRC<0>).
9. Enable the D+ pull-up resistor to signal an attach by setting the DPPULUP bit (U1OTGCON<7>).

REGISTER 20-4: U1OTGCON: USB ON-THE-GO CONTROL REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	r-0	R/W-0	r-0	R/W-0
DPPULUP	DMPULUP	DPPULDWN(1)	DMPULDWN(1)	—	OTGEN(1)	—	VBUSDIS(1)
bit 7							bit 0

Legend:	r = Reserved bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-8 **Unimplemented:** Read as '0'

bit 7 **DPPULUP:** D+ Pull-up Enable bit
1 = D+ data line pull-up resistor is enabled
0 = D+ data line pull-up resistor is disabled

bit 6 **DMPULUP:** D- Pull-up Enable bit
1 = D- data line pull-up resistor is enabled
0 = D- data line pull-up resistor is disabled

bit 5 **DPPULDWN:** D+ Pull-Down Enable bit(1)
1 = D+ data line pull-down resistor is enabled
0 = D+ data line pull-down resistor is disabled

bit 4 **DMPULDWN:** D- Pull-Down Enable bit(1)
1 = D- data line pull-down resistor is enabled
0 = D- data line pull-down resistor is disabled

bit 3 **Reserved:** Maintain as '0'

bit 2 **OTGEN:** OTG Features Enable bit(1)
1 = USB OTG is enabled; all D+/D- pull-up and pull-down bits are enabled
0 = USB OTG is disabled; D+/D- pull-up and pull-down bits are controlled in hardware by the settings of the HOSTEN and USBEN (U1CON<3,0>) bits

bit 1 **Reserved:** Maintain as '0'

bit 0 **VBUSDIS:** VBUS Discharge Enable bit(1)
1 = VBUS line is discharged through a resistor
0 = VBUS line is not discharged

Note 1: These bits are only used in Host mode; do not use in Device mode.

REGISTER 21-6: PMCSxBS: EPMP CHIP SELECT x BASE ADDRESS REGISTER(2)

R/W(1)	R/W(1)	R/W(1)	R/W(1)	R/W(1)	R/W(1)	R/W(1)	R/W(1)
BASE<23:16>							
bit 15							bit 8

R/W(1)	U-0	U-0	U-0	R/W(1)	U-0	U-0	U-0
BASE15	—	—	—	BASE11	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-7 **BASE<23:15>:** Chip Select x Base Address bits(1)

bit 6-4 **Unimplemented:** Read as '0'

bit 3 **BASE11:** Chip Select x Base Address bit(1)

bit 2-0 **Unimplemented:** Read as '0'

Note 1: The value at POR is 0080h for PMCS1BS and 8080h for PMCS2BS.

2: If the whole PMCS2BS register is written together as 0x0000, then the last EDS address for the Chip Select 1 will be FFFFFFh. In this case, Chip Select 2 should not be used. PMCS1BS has no such feature.

REGISTER 21-8: PMSTAT: EPMP STATUS REGISTER (SLAVE MODE ONLY)

R-0, HSC	R/W-0, HS	U-0	U-0	R-0, HSC	R-0, HSC	R-0, HSC	R-0, HSC
IBF	IBOV	—	—	IB3F(1)	IB2F(1)	IB1F(1)	IB0F(1)
bit 15							bit 8

R-1, HSC	R/W-0, HS	U-0	U-0	R-1, HSC	R-1, HSC	R-1, HSC	R-1, HSC
OBE	OBUF	—	—	OB3E	OB2E	OB1E	OB0E
bit 7							bit 0

Legend:	HS = Hardware Settable bit	HSC = Hardware Settable/Clearable bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **IBF:** Input Buffer Full Status bit
1 = All writable Input Buffer registers are full
0 = Some or all of the writable Input Buffer registers are empty

bit 14 **IBOV:** Input Buffer Overflow Status bit
1 = A write attempt to a full Input register occurred (must be cleared in software)
0 = No overflow occurred

bit 13-12 **Unimplemented:** Read as '0'

bit 11-8 **IB3F:IB0F:** Input Buffer x Status Full bits(1)
1 = Input buffer contains unread data (reading the buffer will clear this bit)
0 = Input buffer does not contain unread data

bit 7 **OBE:** Output Buffer Empty Status bit
1 = All readable Output Buffer registers are empty
0 = Some or all of the readable Output Buffer registers are full

bit 6 **OBUF:** Output Buffer Underflow Status bit
1 = A read occurred from an empty Output Buffer register (must be cleared in software)
0 = No underflow occurred

bit 5-4 **Unimplemented:** Read as '0'

bit 3-0 **OB3E:OB0E:** Output Buffer x Status Empty bit
1 = Output Buffer x is empty (writing data to the buffer will clear this bit)
0 = Output Buffer x contains untransmitted data

Note 1: Even though an individual bit represents the byte in the buffer, the bits corresponding to the word (Byte 0 and 1, or Byte 2 and 3) get cleared, even on byte reading.

22.2 RTCC Module Registers

The RTCC module registers are organized into four categories:

- RTCC Control Registers
- RTCC Value Registers
- Alarm Value Registers
- Timestamp Registers

22.2.1 REGISTER MAPPING

Previous RTCC implementations used a Register Pointer to access the RTCC Time and Date registers, as well as the Alarm Time and Date registers. These Registers are now mapped to memory and are individually addressable.

22.2.2 WRITE LOCK

To prevent spurious changes to the RTCC Control or RTCC Value registers, the WRLOCK bit (RTCCON1L<11>) must be cleared (‘0’). The POR default state is the WRLOCK bit is ‘0’ and is cleared on any device Reset (POR, BOR, $\overline{\text{MCLR}}$). It is recommended that the WRLOCK bit be set to ‘1’ after the RTCC Value registers are properly initialized, and after the RTCEN bit (RTCCON1L<15>) has been set.

Any attempt to write to the RTCEN bit, the RTCCON2L/H registers or the RTCC Value registers, will be ignored as long as WRLOCK is ‘1’. The RTCC Control, Alarm Value and Timestamp registers can be changed when WRLOCK is ‘1’.

Clearing the WRLOCK bit requires an unlock sequence after it has been written to a ‘1’, writing two bytes consecutively to the NVMKEY register. A sample assembly sequence is shown in Example 22-1. If WRLOCK is already cleared, it can be set to ‘1’ without using the unlock sequence.

Note:	To avoid accidental writes to the timer, it is recommended that the WRLOCK bit (RTCCON1L<11>) is kept clear at any other time. For the WRLOCK bit to be set, there is only one instruction cycle time window allowed between the 55h/AA sequence and the setting of WRLOCK; therefore, it is recommended that code follow the procedure in Example 22-1.

22.2.3 SELECTING RTCC CLOCK SOURCE

The clock source for the RTCC module can be selected using the CLKSEL<1:0> bits in the RTCCON2L register. When the bits are set to ‘00’, the Secondary Oscillator (SOSC) is used as the reference clock and when the bits are ‘01’, LPRC is used as the reference clock. When CLKSEL<1:0> = 10, the external power-line (50 Hz and 60 Hz) is used as the clock source. When CLKSEL<1:0> = 11, the system clock is used as the clock source.

EXAMPLE 22-1: SETTING THE WRLOCK BIT

```
DISI #6                    ;disable interrupts for 6 instructions
MOV  #NVKEY, W1
MOV  #0x55, W2             ; first unlock code
MOV  W2, [W1]              ; write first unlock code
MOV  #0xAA, W3             ; second unlock sequence
MOV  W3, [W1]              ; write second unlock sequence
BCLR RTCCON1L, #WRLOCK     ; clear the WRLOCK bit
```

REGISTER 22-5: RTCCON3L: RTCC CONTROL REGISTER 3 (LOW)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PWCSAMP7	PWCSAMP6	PWCSAMP5	PWCSAMP4	PWCSAMP3	PWCSAMP2	PWCSAMP1	PWCSAMP0
bit 15							bit 8

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
PWCSTAB7	PWCSTAB6	PWCSTAB5	PWCSTAB4	PWCSTAB3	PWCSTAB2	PWCSTAB1	PWCSTAB0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-8 **PWCSAMP<7:0>:** Power Control Sample Window Timer bits
11111111 = Sample window is always enabled, even when PWCEN = 0
11111110 = Sample window is 254 TPWCCLK clock periods
•
•
•
00000001 = Sample window is 1 TPWCCLK clock period
00000000 = No sample window

bit 7-0 **PWCSTAB<7:0>:** Power Control Stability Window Timer bits(1)
11111111 = Stability window is 255 TPWCCLK clock periods
11111110 = Stability window is 254 TPWCCLK clock periods
•
•
•
00000001 = Stability window is 1 TPWCCLK clock period
00000000 = No stability window; sample window starts when the alarm event triggers

Note 1: The sample window always starts when the stability window timer expires, except when its initial value is 00h.

REGISTER 22-17: TSADATEL: RTCC TIMESTAMP A DATE REGISTER (LOW)(1)

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	DAYTEN1	DAYTEN0	DAYONE3	DAYONE2	DAYONE1	DAYONE0
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0
—	—	—	—	—	WDAY2	WDAY1	WDAY0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 **Unimplemented:** Read as '0'

bit 13-12 **DAYTEN<1:0>:** Binary Coded Decimal Value of Days '10' Digit bits
Contains a value from 0 to 3.

bit 11-8 **DAYONE<3:0>:** Binary Coded Decimal Value of Days '1' Digit bits
Contains a value from 0 to 9.

bit 7-3 **Unimplemented:** Read as '0'

bit 2-0 **WDAY<2:0>:** Binary Coded Decimal Value of Weekdays '1' Digit bits
Contains a value from 0 to 6.

Note 1: If TSAEN = 0, bits<15:0> can be used for persistence storage throughout a non-Power-on Reset ($\overline{\text{MCLR}}$, WDT, etc.).

TABLE 33-6: DC CHARACTERISTICS: POWER-DOWN CURRENT (I_{PD})

DC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial			
Parameter No.	**Typical(1)**	**Max**	**Units**	**Operating Temperature**	**VDD**	**Conditions**
Power-Down Current(4,5)						
DC60	2.5	10	µA	-40°C	2.0V	Sleep(2)
	3.2	10	µA	+25°C		
	11.5	45	µA	+85°C		
	3.2	10	µA	-40°C	3.3V	
	4.0	10	µA	+25°C		
	12.2	45	µA	+85°C		
DC61	165	—	nA	-40°C	2.0V	Low-Voltage Retention Sleep(3)
	190	—	nA	+25°C		
	14.5	—	µA	+85°C		
	220	—	nA	-40°C	3.3V	
	300	—	nA	+25°C		
	15	—	µA	+85°C		

Note 1: Data in the "Typical" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: The retention low-voltage regulator is disabled; RETEN (RCON<12>) = 0, $\overline{\text{LPCFG}}$ (FPOR<2>) = 1.

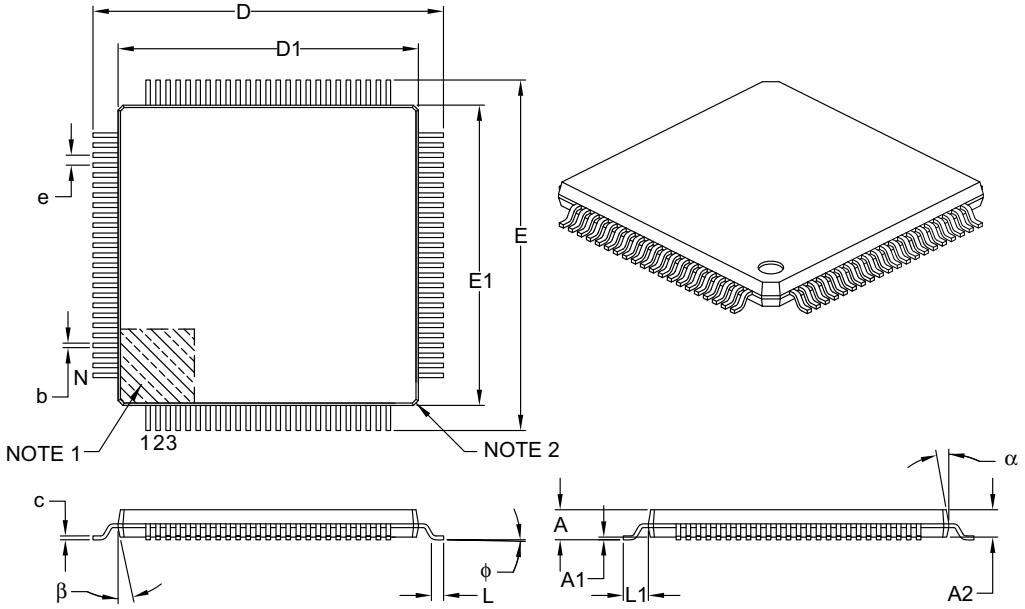
3: The retention low-voltage regulator is enabled; RETEN (RCON<12>) = 1, $\overline{\text{LPCFG}}$ (FPOR<2>) = 0.

4: Base I_{PD} is measured with all peripherals and clocks shut down. All I/Os are configured as outputs and driven low. WDT, etc., are all switched off.

5: These currents are measured on the device containing the most memory in this family.

100-Lead Plastic Thin Quad Flatpack (PT) – 12x12x1 mm Body, 2.00 mm [TQFP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Leads	N		100	
Lead Pitch	e		0.40 BSC	
Overall Height	A	–	–	1.20
Molded Package Thickness	A2	0.95	1.00	1.05
Standoff	A1	0.05	–	0.15
Foot Length	L	0.45	0.60	0.75
Footprint	L1		1.00 REF	
Foot Angle	ϕ	0°	3.5°	7°
Overall Width	E		14.00 BSC	
Overall Length	D		14.00 BSC	
Molded Package Width	E1		12.00 BSC	
Molded Package Length	D1		12.00 BSC	
Lead Thickness	c	0.09	–	0.20
Lead Width	b	0.13	0.18	0.23
Mold Draft Angle Top	α	11°	12°	13°
Mold Draft Angle Bottom	β	11°	12°	13°

Notes:

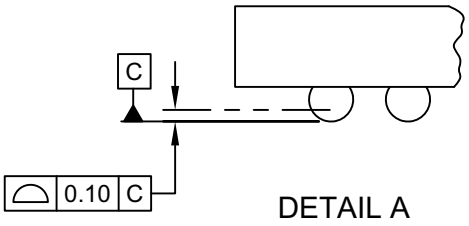
1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Chamfers at corners are optional; size may vary.
3. Dimensions D1 and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

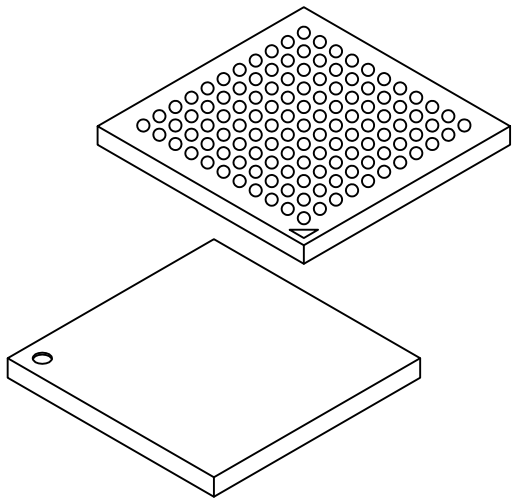
Microchip Technology Drawing C04-100B

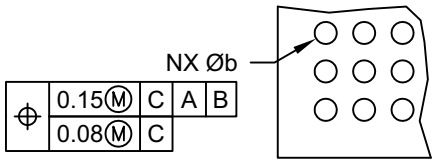
121-Ball Plastic Thin Profile Fine Pitch Ball Grid Array (BG) - 10x10x1.10 mm Body [TFBGA]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



DETAIL A





DETAIL B

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Contacts	N		121	
Contact Pitch	e		0.80 BSC	
Overall Height	A	1.00	1.10	1.20
Ball Height	A1	0.25	0.30	0.35
Overall Width	E		10.00 BSC	
Array Width	E1		8.00 BSC	
Overall Length	D		10.00 BSC	
Array Length	D1		8.00 BSC	
Contact Diameter	b	0.35	0.40	0.45

Notes:

1. Ball A1 visual index feature may vary, but must be located within the hatched area.
2. Dimensioning and tolerancing per ASME Y14.5M.
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.
   REF: Reference Dimension, usually without tolerance, for information purposes only.
3. The outer rows and colums of balls are located with respect to datums A and B.
4. Ball interface to package body: 0.37mm nominal diameter.

Microchip Technology Drawing C04-148 Rev F Sheet 2 of 2

APPENDIX A: REVISION HISTORY

Revision A (March 2015)

Original data sheet for the PIC24FJ1024GA610/GB610 family of devices.

Revision B (November 2015)

This revision incorporates the following updates:

- Sections:
  - Changed 12-bit conversion rate to 200 ksps in the Analog Features section on Page 1.
  - Added Smart Card support (ISO 7816) information to the Peripheral Features section on Page 2.
  - Added **Section 9.3.1 "DCO Overview"**.
  - Added **Section 25.4 "Achieving Maximum A/D Converter (ADC) Performance"**.
  - Added **Section 30.2 "Unique Device Identifier (UDID)"**.
  - Updated **Section 6.6 "Programming Operations"**, **Section 9.6 "PLL Oscillator Modes and USB Operation"**, **Section 9.6.1 "Considerations for USB Operation"**, **Section 9.7 "Reference Clock Output"**, **Section 9.8 "Secondary Oscillator"**, **Section 10.2 "Instruction-Based Power-Saving Modes"**, **Section 10.2.2 "Idle Mode"**, **Section 12.0 "Timer1"**, **Section 16.1 "Time Base Generator"** and **Section 33.0 "Electrical Characteristics"**
- Registers
  - Updated Register 5-1, Register 6-1, Register 7-1, Register 9-4, Register 9-5, Register 18-1, Register 22-3, Register 25-2, Register 25-3, Register 25-6, Register 25-7, Register 30-1, Register 30-5, Register 30-7, Register 30-8 and Register 30-9
- Figures:
  - Updated Figure 2-1, Figure 9-2 and Figure 25-3
  - Added Figure 33-5, Figure 33-6, Figure 33-7 and Figure 33-8
- Tables:
  - Updated Table 2-1, Table 4-1, Table 4-2, Table 4-3, Table 4-10, Table 9-2, Table 9-3, Table 30-1, Table 33-3, Table 33-4, Table 33-5, Table 33-6, Table 33-7, Table 33-8, Table 33-9, Table 33-11, Table 33-12, Table 33-13, Table 33-15, Table 33-19, Table 33-24, Table 33-25 and Table 33-26.
- Examples:
  - Updated Example 15-1.
- Other minor typographic changes and updates throughout the document.

Revision C (November 2015)

This revision incorporates the following updates:

- Tables:
  - Updated Table 33-5 and Table 33-20.
- Figures:
  - Updated Figure 33-8.

Revision D (December 2016)

This revision incorporates the following updates:

- Sections:
  - Added **Section 8.1.1 "Alternate Interrupt Vector Table"**, **Section 8.4.1 "INTCON1-INTCON4"** and **Section 10.2.5 "Exiting from Low-Voltage Retention Sleep"**.
  - Updated the **"Referenced Sources"** section. Updated **Section 4.1.2 "Dual Partition Flash Program Memory Organization"** **Section 4.1.5 "Code-Protect Configuration Bits"**, **Section 8.1.1 "Alternate Interrupt Vector Table"**, **Section 8.4 "Interrupt Control and Status Registers"**, **Section 9.0 "Oscillator Configuration"**, **Section 10.2.4 "Low-Voltage Retention Regulator"**, **Section 11.3 "Interrupt-on-Change (IOC)"**, **Section 11.4.2 "Available Peripherals"**, **Section 17.0 "Serial Peripheral Interface (SPI)"**, **Section 22.0 "Real-Time Clock and Calendar with Timestamp"** and **Section 22.2.2 "Write Lock"**.
- Tables:
  - Added Table 8-1.
  - Updated Table 4, Table 5, Table 6, Table 7, Table 1-3, Table 8-1, Table 9-1, Table 9-2, Table 9-3, Table 11-4, Table 33-4, Table 33-5, Table 33-6 and Table 33-7.
- Figures:
  - Updated Figure 8-1, Figure 9-1, Figure 9-2 and Figure 22-1.
- Examples:
  - Updated Example 11-3, Example 15-1 and Example 22-1.
- Equations:
  - Updated Equation 15-2.
- Registers:
  - Updated Register 7-1, Register 9-8, Register 17-1, Register 27-1 and Register 30-10.

D

E